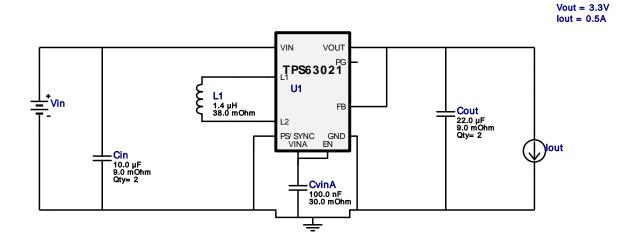


WEBENCH® Design Report

VinMin = 2.7V VinMax = 4.2V Vout = 3.3V Iout = 0.5A

Device = TPS63021DSJR Topology = Buck_Boost Created = 12/3/16 10:42:46 AM BOM Cost = \$1.46 BOM Count = 7 Total Pd = 0.18W

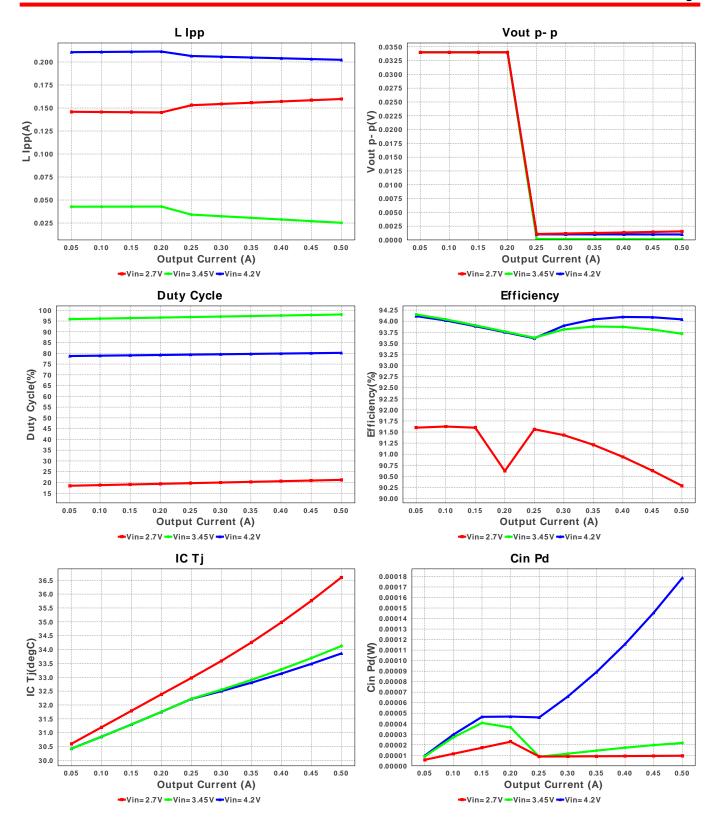
Design : 3569363/75 TPS63021DSJR TPS63021DSJR 2.7V-4.2V to 3.30V @ 0.5A

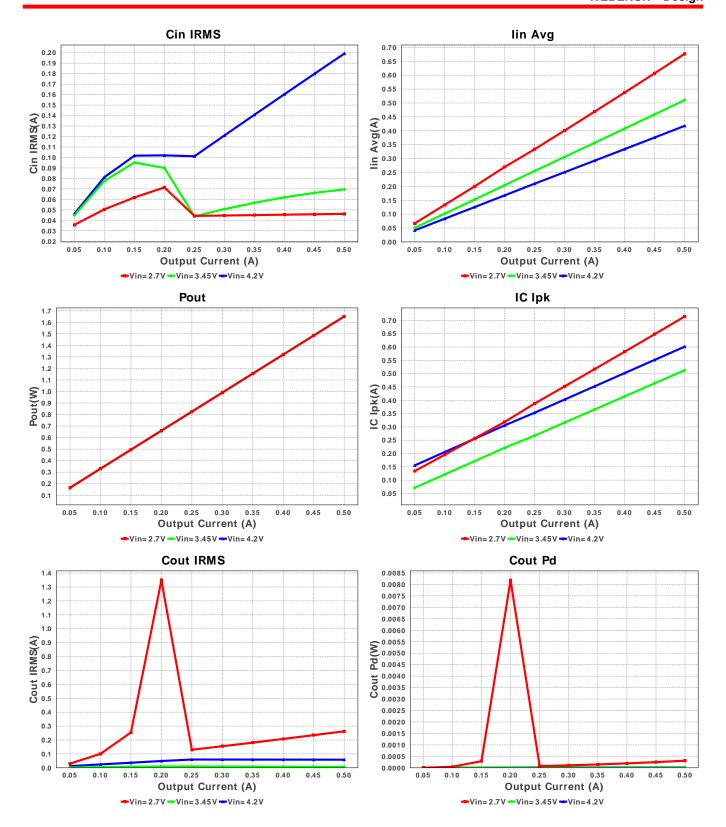


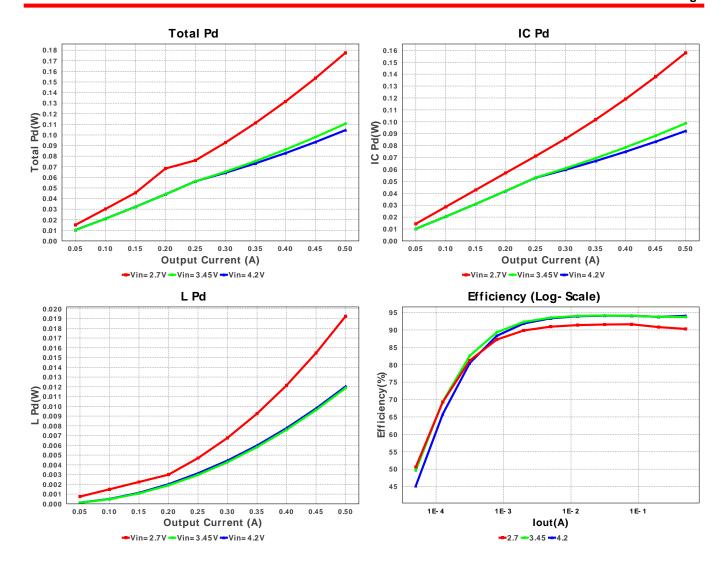
Electrical BOM

| # | Name | Manufacturer | Part Number | Properties | Qty | Price | Footprint |
|----|-------|-------------------|-----------------------------------|---|-----|--------|----------------------------|
| 1. | Cin | MuRata | GRM188R60J106ME47D Series= X5R | Cap= 10.0 uF ESR= 9.0 mOhm VDC= 6.3 V IRMS= 2.74 A | 2 | \$0.02 | 0603 5 mm ² |
| 2. | Cout | MuRata | GRM21BR60J226ME39L Series= X5R | Cap= 22.0 uF ESR= 9.0 mOhm VDC= 6.3 V IRMS= 3.5 A | 2 | \$0.04 | 0805 7 mm ² |
| 3. | CvinA | MuRata | GRM188R70J104KA01D Series= X7R | Cap= 100.0 nF ESR= 30.0 mOhm VDC= 6.3 V IRMS= 1.75 A | 1 | \$0.01 | 0603 5 mm ² |
| 4. | L1 | Bourns | SDR0403-1R4ML | L= 1.4 μH DCR= 38.0 mOhm | 1 | \$0.18 | SDR0403 28 mm ² |
| 5. | U1 | Texas Instruments | TPS63021DSJR | Switcher | 1 | \$1.15 | P. DVSON NAA 20 mm² |

R-PVSON-N14 20 mm²







Operating Values

| Name | Value | Category | Description |
|----------------|--|--|--|
| Cin IRMS | 46.126 mA | Current | Input capacitor RMS ripple current |
| Cout IRMS | 262.654 mA | Current | Output capacitor RMS ripple current |
| IC lpk | 714.515 mA | Current | Peak switch current in IC |
| lin Avg | 676.84 mA | Current | Average input current |
| L lpp | 159.79 mA | Current | Peak-to-peak inductor ripple current |
| BOM Count | 7 | General | Total Design BOM count |
| FootPrint | 75.0 mm ² | General | Total Foot Print Area of BOM components |
| Frequency | 2.4 MHz | General | Switching frequency |
| IC Tolerance | 5.0 mV | General | IC Feedback Tolerance |
| Mode | PWM | General | PWM/PFM Mode |
| Pout | 1.65 W | General | Total output power |
| Total BOM | \$1.46 | General | Total BOM Cost |
| Duty Cycle | 21.213 % | Op_point | Duty cycle |
| Efficiency | 90.288 % | Op_point | Steady state efficiency |
| IC Tj | 36.601 degC | Op_point | IC junction temperature |
| ICThetaJA | 41.8 degC/W | Op_point | IC junction-to-ambient thermal resistance |
| IOUT_OP | 500.0 mA | Op_point | lout operating point |
| VIN_OP | 2.7 V | Op_point | Vin operating point |
| Vout p-p | 1.221 mV | Op_point | Peak-to-peak output ripple voltage |
| Cin Pd | 9.574 μW | Power | Input capacitor power dissipation |
| Cout Pd | 310.442 µW | Power | Output capacitor power dissipation |
| IC Pd | 157.917 mW | Power | IC power dissipation |
| L Pd | 19.231 mW | Power | Inductor power dissipation |
| Total Pd | 177.484 mW | Power | Total Power Dissipation |
| Vout Tolerance | 151.52 m% | | Vout Tolerance based on IC Tolerance (no load) and voltage divider resistors if applicable |
| | Cout IRMS IC Ipk lin Avg L Ipp BOM Count FootPrint Frequency IC Tolerance Mode Pout Total BOM Duty Cycle Efficiency IC Tj ICThetaJA IOUT_OP VIN_OP Vout p-p Cin Pd Cout Pd IC Pd L Pd Total Pd | Cin IRMS Cout IR | Cin IRMS |

Design Inputs

| # | Name | Value | Description |
|----|------|---------|------------------------|
| 1. | lout | 500.0 m | Maximum Output Current |

| # | Name | Value | Description |
|----|---------|----------|-----------------------|
| 2. | VinMax | 4.2 | Maximum input voltage |
| 3. | VinMin | 2.7 | Minimum input voltage |
| 4. | Vout | 3.3 | Output Voltage |
| 5. | base_pn | TPS63021 | Base Product Number |
| 6. | source | DC | Input Source Type |
| 7. | Ta | 30.0 | Ambient temperature |

Design Assistance

1. TPS63021 Product Folder: http://www.ti.com/product/TPS63021: contains the data sheet and other resources.

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